L Number	Hits		DB	Time stamp
1	33	(atsushi near3 oohashi).in.	USPAT; US-PGPUB	2002/11/27 12:42
2	5	(shoichiro near3 nishitani).in.	USPAT; US-PGPUB	2002/11/27 12:22
4	0	310/254.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/27 12:49
5	0	310/180.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/27 12:51
6	0	310/208.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:33
3	1.	310/179.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:51
7	0	310/210.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:36
8	0	310/216.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:38
9	O	310/235.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:41
10	0	310/259.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:45
11	0	310/234.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/27 13:48
12	0	310/260.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 13:51
13	25	310/\$.ccls. and (low\$4 adj3 melt\$4 adj3 point) near20 (conduct\$10 wind\$4)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 14:18
14	270	310/201.ccls.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2002/11/27 15\$08
22	1301	310/71.ccls.	DERWENT; IBM_TDB USPAT;	/ x 2002/11/27 14:52
23	6	310/201.ccls. and (cu-p ag sn)	US-PGPUB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/11/27 15:12

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24	113	310/201.ccls. and (copper\$12 silver tin)	USPAT;	2002/11/27 16:19	7
			US-PGPUB;		
			EPO; JPO;		
			DERWENT;		
	191	210/21	IBM_TDB	2002 (11 (25 15 10	
25	191	, ((USPAT;	2002/11/27 16:10	
		same (conduct\$5 segment)	US-PGPUB;		
			EPO; JPO;		-
			DERWENT;		Ì
0.0	10	210/201 ggls and (1+ ggldowts) noom10	IBM_TDB	2002/11/27 16 20	
26	10	310/201.ccls. and (molten solder\$5) near10 (alloy conductor)	USPAT;	2002/11/27 16:20	
		(alloy conductor)	US-PGPUB; EPO; JPO;		ļ
		·	DERWENT:		1
		,	IBM TDB		
27	78	310/71.ccls. and (molten solder\$5) near10	USPAT:	2002/11/27 16:29	
27	'0	(alloy conductor)	US-PGPUB;	2002/11/2/ 10.29	1,64
		(arroy conductor)	EPO; JPO;		
			DERWENT;		
			IBM TDB		-
28	36	310/71.ccls. and (molten solder\$5) near10	USPAT:	2002/11/27 16:36	1
		(alloy cu copper)	US-PGPUB;	=====================================	
		(EPO; JPO;		-
			DERWENT;		
			IBM TDB		
29	3	310/201.ccls. and (molten solder\$5) near10	USPAT:	2002/11/27 16:30	
		(alloy cu copper)	US-PGPUB;		
			EPO; JPO;		
			DERWENT;		
			IBM TDB		